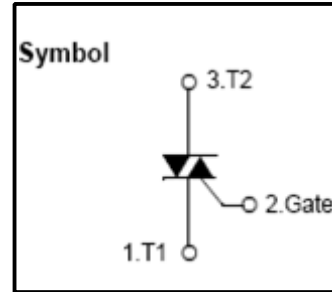


Bi-Directional Triode Thyristor

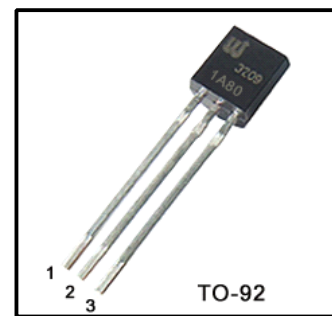
Features

- Repetitive Peak off-State Voltage:800V
- R.M.S On-State Current($I_{T(RMS)}$)=1A
- Low on-state voltage: $V_{TM}=1.2(\text{typ.})@ I_{TM}$
- Low reverse and forward blocking current:
 $I_{DRM}=500\mu A@TC=125^{\circ}C$
- Low holding current: $I_H=4mA$ (typ.)
- High Commutation dV/dt .



General Description

General purpose switching and phase control applications. These devices are intended to be interfaced directly to micro-controllers, logic integrated circuits and other low power gate trigger circuits such as fan speed and temperature modulation control, lighting control and static switching relay.



Absolute Maximum Ratings ($T_J=25^{\circ}C$ unless otherwise specified)

symbol	Parameter	condition	Ratings	Units
V_{DRM}	Repetitive Peak Off-State Voltage		800	V
$I_{T(RMS)}$	R.M.S On-State Current	$T_c=86^{\circ}C$	1	A
I_{TSM}	Surge On-State Current	Full sine wave, 20/16.7ms	12.5/13.8	A
I^2t	I^2t		1.28	A^2s
P_{GM}	Peak Gate Power Dissipation		5.0	W
$P_{G(AV)}$	Average Gate Power Dissipation		0.5	W
I_{GM}	Peak Gate Current		2.0	A
V_{GM}	Peak Gate Voltage		5	V
T_J	Operating Junction Temperature		125	$^{\circ}C$
T_{STG}	Storage Temperature		-40~150	$^{\circ}C$

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta Jc}$	Thermal Resistance Junction to Case	60	$^{\circ}C/W$

Electrical Characteristics($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Items	conditions	Ratin			Unit	
			Min	Typ	Max		
I_{DRM}	Repetitive Peak Off-State Current	$V_D=V_{\text{DRM}}$, Single Phase, Half Wave $T_J=125^{\circ}\text{C}$	-	0.1	0.5	mA	
V_{TM}	Peak On-State Voltage	$I_T=35\text{A}$, Inst. Measurement	-	1.2	1.5	V	
I_{GT}	Gate Trigger Current	$V_D=12\text{V}$, $R_L=100\Omega$	T2+G+	-	0.4	5	mA
			T2+G-	-	1.3	5	
			T2-G-	-	1.4	5	
			T2-G+	-	3.8	7	
V_{GT}	Gate Trigger Voltage	$V_D=12\text{V}$, $R_L=100\Omega$	T2+G+	-	-	1.5	V
			T2+G-	-	-	1.5	
			T2-G-	-	-	1.5	
			T2-G+	-	-	1.5	
V_{GD}	Non-Trigger Gate Voltage	$T_J=125^{\circ}\text{C}$, $V_D=V_{\text{DRM}}$, $R_L=3.3\text{K}\Omega$	0.2	-	-	V	
dv/dt	Critical Rate of Rise Off-State Voltage at Commutation	$V_D=67\%V_{\text{DRM(MAX)}}$ $T_J=125^{\circ}\text{C}$, $R_{\text{GK}}=1\text{K}\Omega$	10	20	-	$\text{V}/\mu\text{s}$	
I_{H}	Holding Current	$V_D=12\text{V}$, $I_{\text{GT}}=0.1\text{A}$	-	1.3	5	mA	
I_{L}	Latching current	$V_D=12\text{V}$, $I_{\text{GT}}=0.1\text{A}$	T2+G+	-	1.2	5	mA
			T2+G-	-	4.0	5	
			T2-G-	-	1.0	8	
			T2-G+	-	2.5	5	
tgt	Gate controlled turn-on time	$I_{\text{TM}}=1.5\text{A}$, $V_{\text{DM}}=V_{\text{DRM(MAX)}}$, $I_{\text{G}}=0.1\text{A}$, $di_{\text{G}}/dt=5\text{A}/\mu\text{s}$	-	2	-	μs	

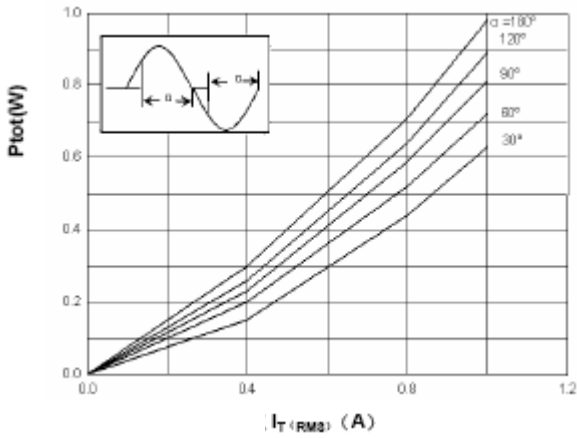


Fig.1. P_{tot} - I_{T(RMS)}

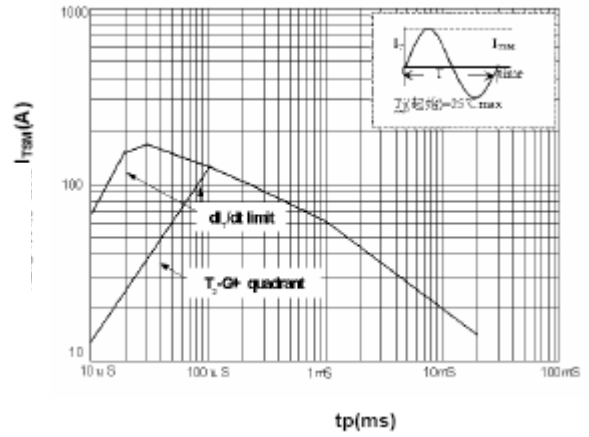


Fig.2 I_{TSM} - tP

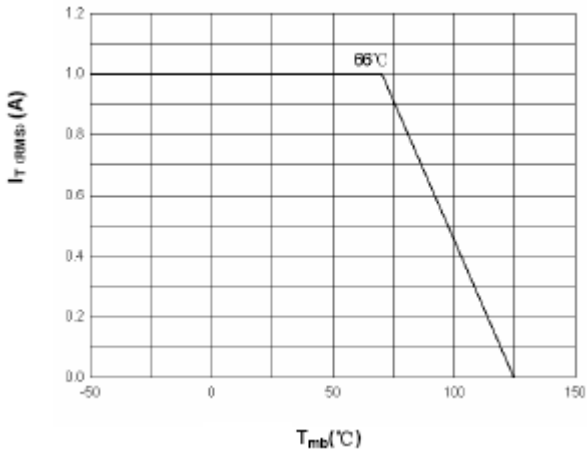


Fig.3 I_{T(RMS)} - T_{mb}

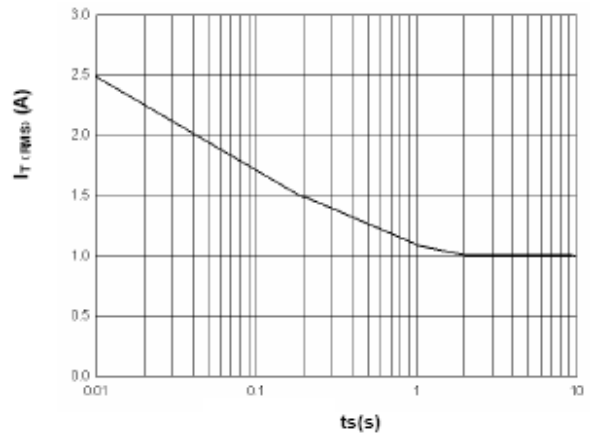


Fig.4 I_{T(RMS)} - t_s

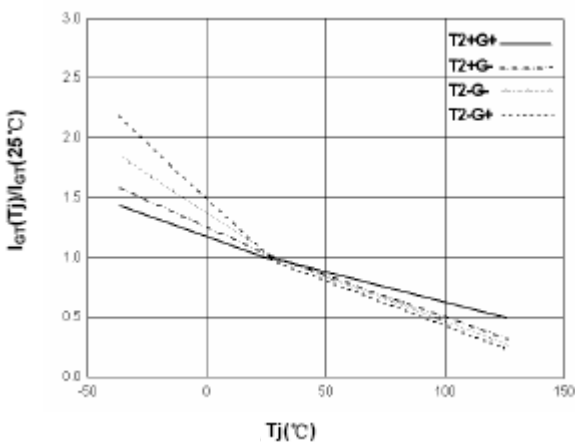


Fig.5 I_{GT(Tj)}/I_{GT(25 C)} - T_j

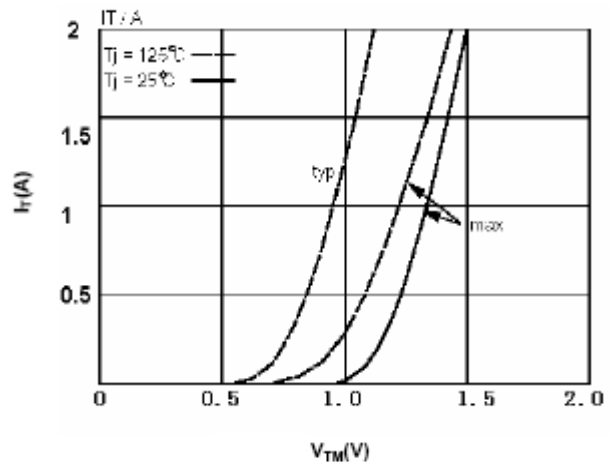


Fig.6 V_{TM} - I_T

TO-92 Package Dimension

